

FM/AM Radio

Description

CXA1691BM/BS is a one-chip FM/AM radio IC designed for radio-cassette tape recorders.

Features

- Small number of peripheral components.
- Low current consumption ($V_{CC}=3\text{ V}$)
For FM : $I_D=5.8\text{ mA}$ (Typ.)
For AM : $I_D=4.7\text{ mA}$ (Typ.)
- Built-in FM/AM select switch.
- Large output of AF amplifier.
 $V_{CC}=6\text{ V}$, EIAJ output=500 mW (Typ.)
when load impedance $8\ \Omega$

Function

FM section

- RF amplifier, Mixer and OSC
(incorporating AFC variable capacitor).
- IF amplifier
- Quadrature detection
- Tuning LED driver

AM section

- RF amplifier, Mixer and OSC (with RF AGC)
- IF amplifier (with IF AGC)
- Detector
- Tuning LED driver

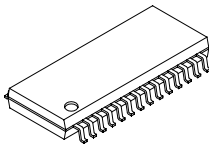
AF section

- Electronic volume control
- FM muting

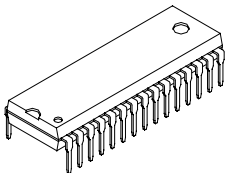
Structure

Bipolar monolithic IC

CXA1691BM
28 pin SOP (Plastic)



CXA1691BS
30 pin SDIP (Plastic)



Absolute Maximum Ratings ($T_a=25\text{ }^{\circ}\text{C}$)

• Supply voltage	V_{CC}	14	V
• Operating temperature	T_{opr}	-10 to +60	$^{\circ}\text{C}$
• Storage temperature	T_{stg}	-50 to +125	$^{\circ}\text{C}$
• Allowable power dissipation	P_D	700	mW (CXA1691BM)
	P_D	1000	mW (CXA1691BS)

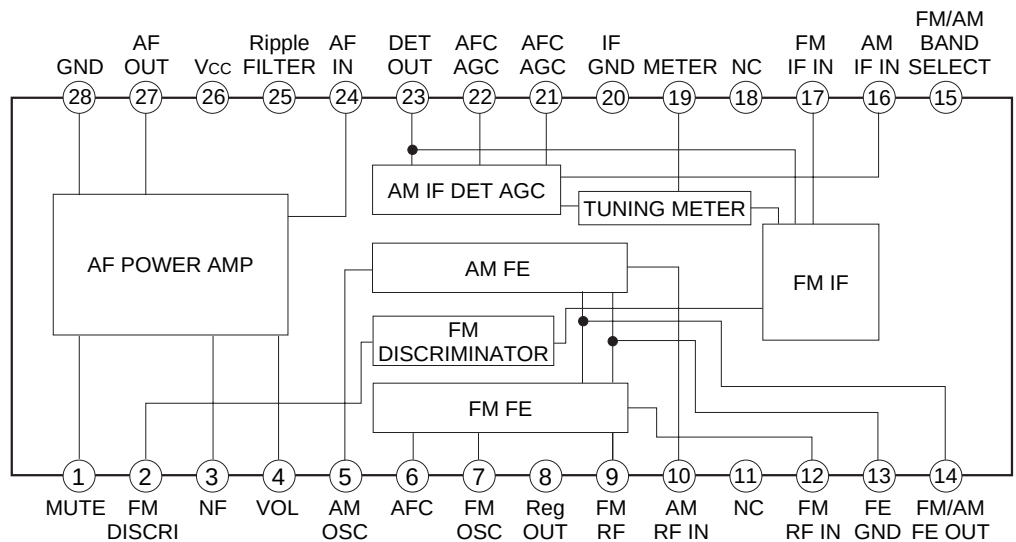
Recommended Operating Conditions

Supply voltage	V_{CC}	2 to 7.5	V (CXA1691BM)
	V_{CC}	2 to 8.5	V (CXA1691BS)

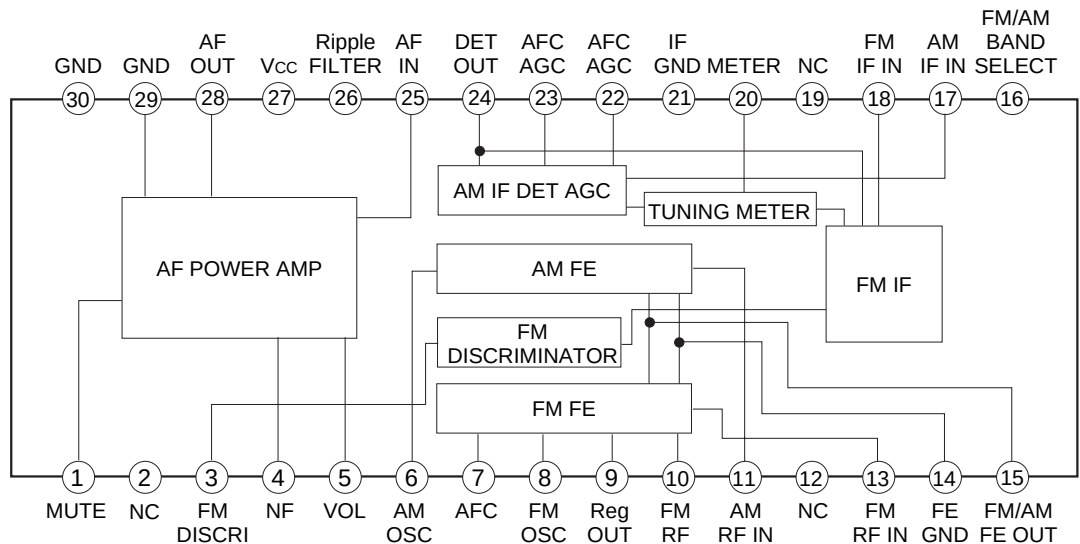
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Block Diagram

CXA1691BM



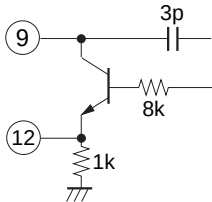
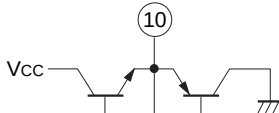
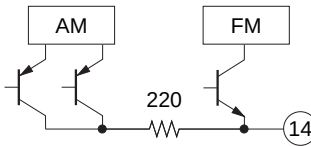
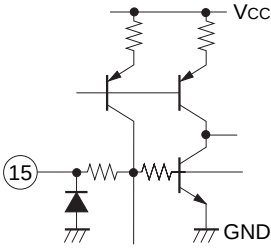
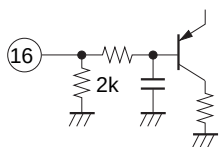
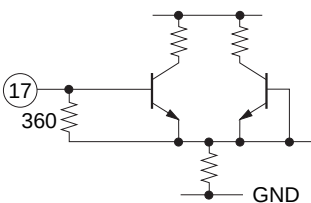
CXA1691BS

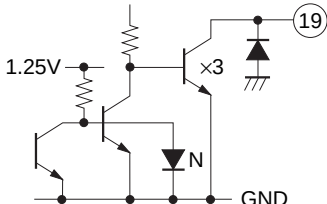
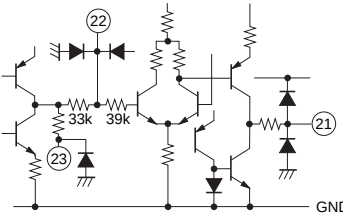
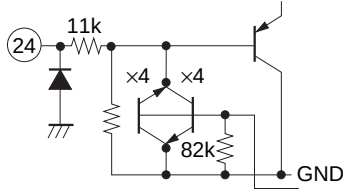
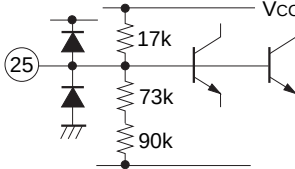


Standard Circuit Design Data

(The pin numbers in the parenthesis are for CXA1691BS.)

No.	Symbol	Voltage (V)				Equivalent circuit	Description
		V _{CC} =3 V		V _{CC} =6 V			
		FM	AM	FM	AM		
1 (1, 2)	MUTE	0	0	0	0		
2 (3)	FM DISCRI	2.18	2.70	4.88	5.43		Phase-shift circuit Connect ceramic discriminator
3 (4)	NF	1.5	1.5	3.0	3.0		Negative feedback pin
27 (28)	AF OUT	1.5	1.5	3.0	3.0		Power amplifier output pin
4 (5)	VOL CONT	1.25	1.25	1.25	1.25		Connect variable resistor for electronic volume control.
5 (6)	AM OSC	1.25	1.25	1.25	1.25		AM local oscillation circuit
6 (7)	AFC	1.25	*	1.25	*		AFC variable capacitor pin
8 (9)	REG OUT	1.25	1.25	1.25	1.25		Regulator pin 1.25 V (Typ.)
7 (8)	FM OSC	1.25	1.25	1.25	1.25		FM local oscillation circuit

No.	Symbol	Voltage (V)				Equivalent circuit	Description
		V _{CC} =3 V		V _{CC} =6 V			
		FM	AM	FM	AM		
9 (10)	FM RF	1.25	1.25	1.25	1.25		Connect FM RF tuning coil
12 (13)	FM RF IN	0.3	0	0.3	0		FM RF input pin
10 (11)	AM RF IN	1.25	1.25	1.25	1.25		AM RF input pin
11 (12)	NC	0	0	0	0		
13 (14)	GND (FE GND)	0	0	0	0		
14 (15)	FM/AM FE OUT	0.36	0.2	0.36	0.2		IF output pin of FM and AM. Connect IF filter.
15 (16)	BAND SELECT	0.84	0	0.88	0		FM and AM bands selection switch pin. During GND it becomes AM and during open it becomes FM.
16 (17)	AM IF IN	0	0	0	0		Input pin of AM IF.
17 (18)	FM IF IN	1.30	0	1.30	0		Input pin of FM IF.
18 (19)	NC	0	0	0	0		

No.	Symbol	Voltage (V)				Equivalent circuit	Description
		V _{CC} =3 V		V _{CC} =6 V			
		FM	AM	FM	AM		
19 (20)	METER	1.6	1.6	4.5	4.5		Meter drive circuit (For tuning indicator)
20 (21)	GND	0	0	0	0		
21 (22)	AFC/AGC	1.25	1.49	1.25	1.49		AFC pin of W band. During AM, it determines time constant of AGC
22 (23)	AFC/AGC	1.25	1.25	1.25	1.25		AFC pin of J band. During AM, it determines time constant of AGC.
23 (24)	DET OUT	1.25	1.0	1.25	1.0		Detection output pin
24 (25)	AF IN	0	0	0	0		Power amplifier input pin
25 (26)	RIPPLE FILTER	2.71	2.71	5.4	5.4		Ripple filter
26 (27)	V _{CC}	3.0	3.0	6.0	6.0		Power supply pin
28 (29, 30)	GND	0	0	0	0		Power GND

* The pin voltage of pin 6 during AM, it is the same pin voltage of pin 22 (23) during J BAND and is the same pin voltage of pin 21 (22) during W BAND.

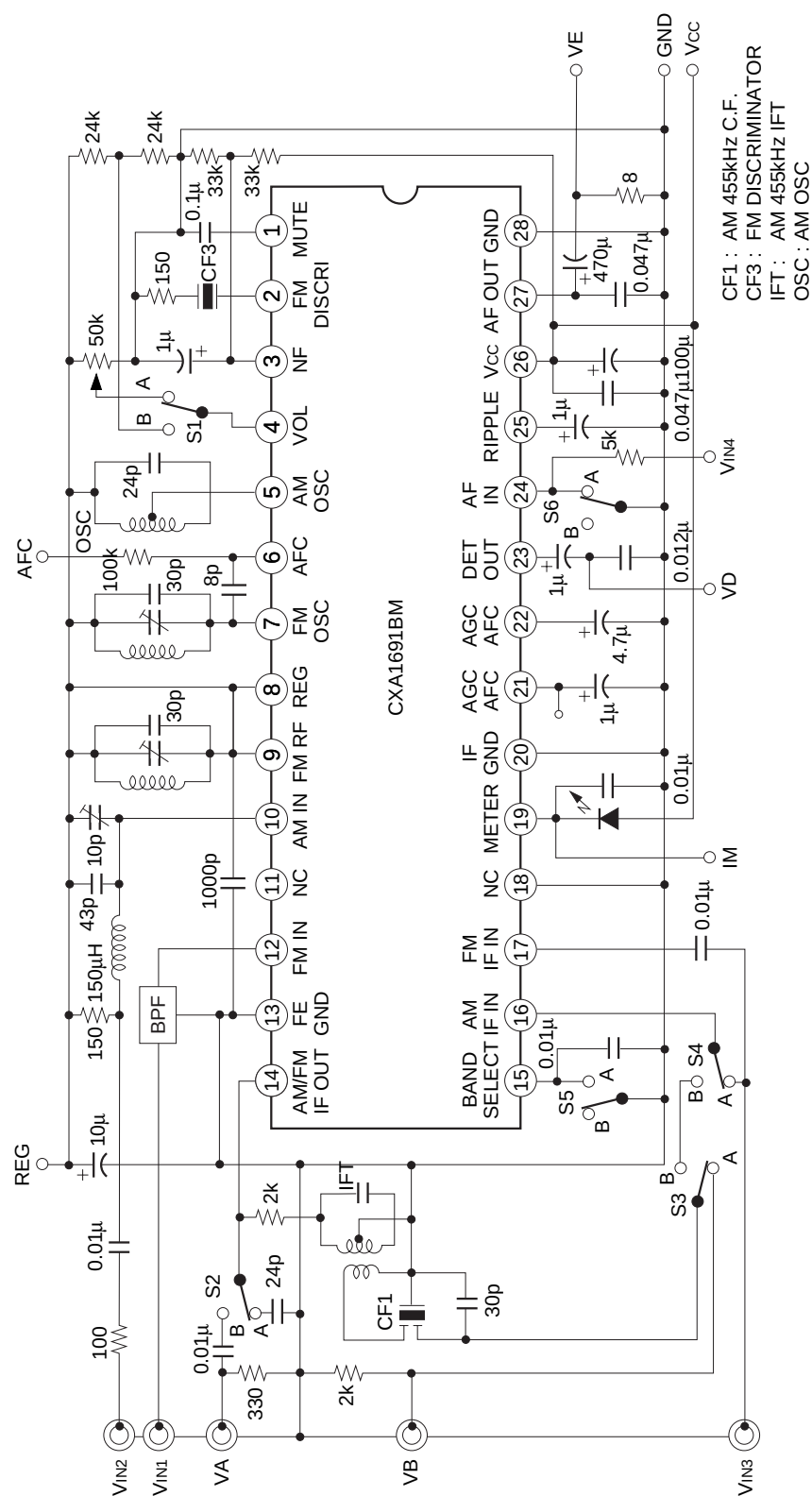
Electrical Characteristics

(See the Electrical Characteristics Test Circuit, Ta=25 °C, Vcc=6 V)

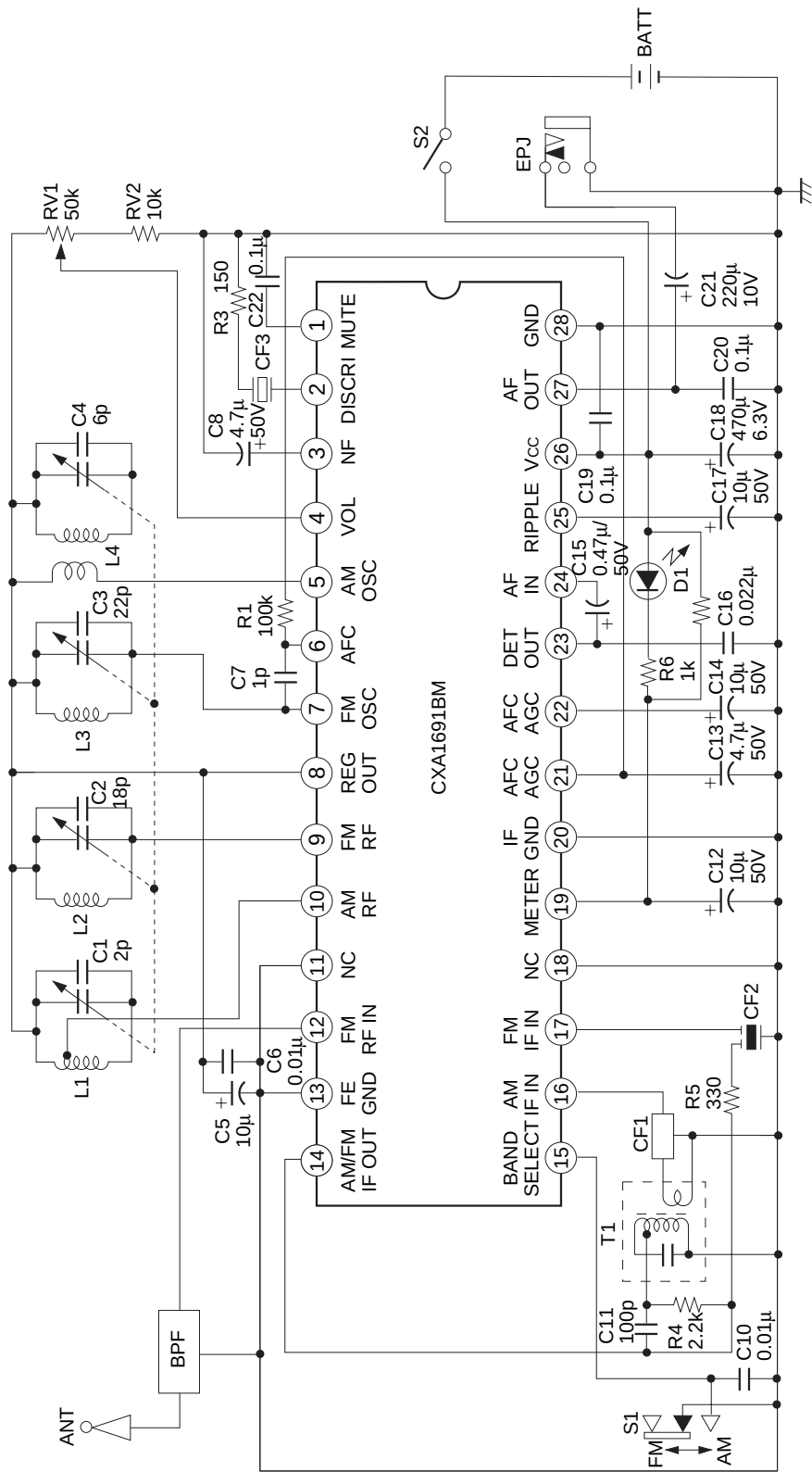
No.	Item	Symbol	SW conditions						Test Point	Conditions	Min.	Typ.	Max.	Unit
			1	2	3	4	5	6						
1	AM circuit current	ID1	A	B	A	A	A	A	IA	No signal, AM	—	4.8	10.0	mA
2	FM circuit current	ID2	A	B	A	A	B	A	IA	No signal, FM	—	7.6	14.0	mA
3	FM front end voltage gain	GV1	A	B	A	A	A	B	VA	V _{IN1} =40 dBμV, 100 MHz	32	39	46	dB
4	FM detection output level	VD1	A	—	—	A	B	A	VD	V _{IN3} =90 dBμV, 10.7 MHz (1 kHz, 22.5 kHz DEV)	39	77.5	155	mVrms
5	FM IF knee level	VD2	A	—	—	A	B	A	VD	V _{IN3} =level at a point 3 dB down from V _{IN3} =90 dBμV, 10.7 MHz (1 kHz, 22.5 kHz DEV)	—	24	32	dBμV
6	FM detection output distortion factor	THD1	A	—	—	A	B	A	VD	V _{IN3} =90 dBμV, 10.7 MHz (1 kHz, 75 kHz DEV)	—	0.3	2.0	%
7	FM meter current	IB1	A	—	—	A	B	A	IM	V _{IN3} =60 dBμV, 10.7 MHz	1.8	3.5	7.0	mA
8	AM front end voltage gain	GV2	A	A	A	A	A	A	VB	V _{IN2} =60 dBμV, 1660 kHz	15	22	29	dB
9	AM IF voltage gain	GV3	A	A	—	A	A	A	VD	V _{IN3} when 455 kHz (1 kHz, 30 % MOD) output is -34 dBm	14	20	27	dBμV
10	AM detection output level	VD3	A	A	—	A	A	A	VD	V _{IN3} =85 dBμV, 455 kHz (1 kHz, 30 % MOD)	39	77.5	155	mVrms
11	AM meter current	IB2	A	A	—	A	A	A	IM	V _{IN3} =85 dBμV, 455 kHz (1 kHz, 30 % MOD)	1.3	3.0	7.0	mA
12	AM detection output distortion factor	THD2	A	A	B	B	A	A	VD	V _{IN2} =95 dBμV, 1660 kHz (1 kHz, 30 % MOD)	—	0.6	2.0	%
13	Audio voltage gain	GV4	A	—	—	—	—	B	VE	V _{IN3} =60 dBμV, 10.7 MHz V _{IN4} =-30 dBm, 1 kHz	27	31.5	36	dB
14	Audio distortion factor	THD3	A	—	—	—	—	B	VE	Distortion factor for 50 mW output V _{IN3} =60 dBμV, 10.7 MHz V _{IN4} =-20 dBm, 1 kHz	—	0.9	2.5	%
15	Muting level	VD4	A	—	—	—	—	B	VE	Muting level for 50 mW output V _{IN4} =-20dBm, 1 kHz Attenuation for 60 dBμV input with V _{IN3} OFF	8	15	22	dB

0 dBμV=1 μV

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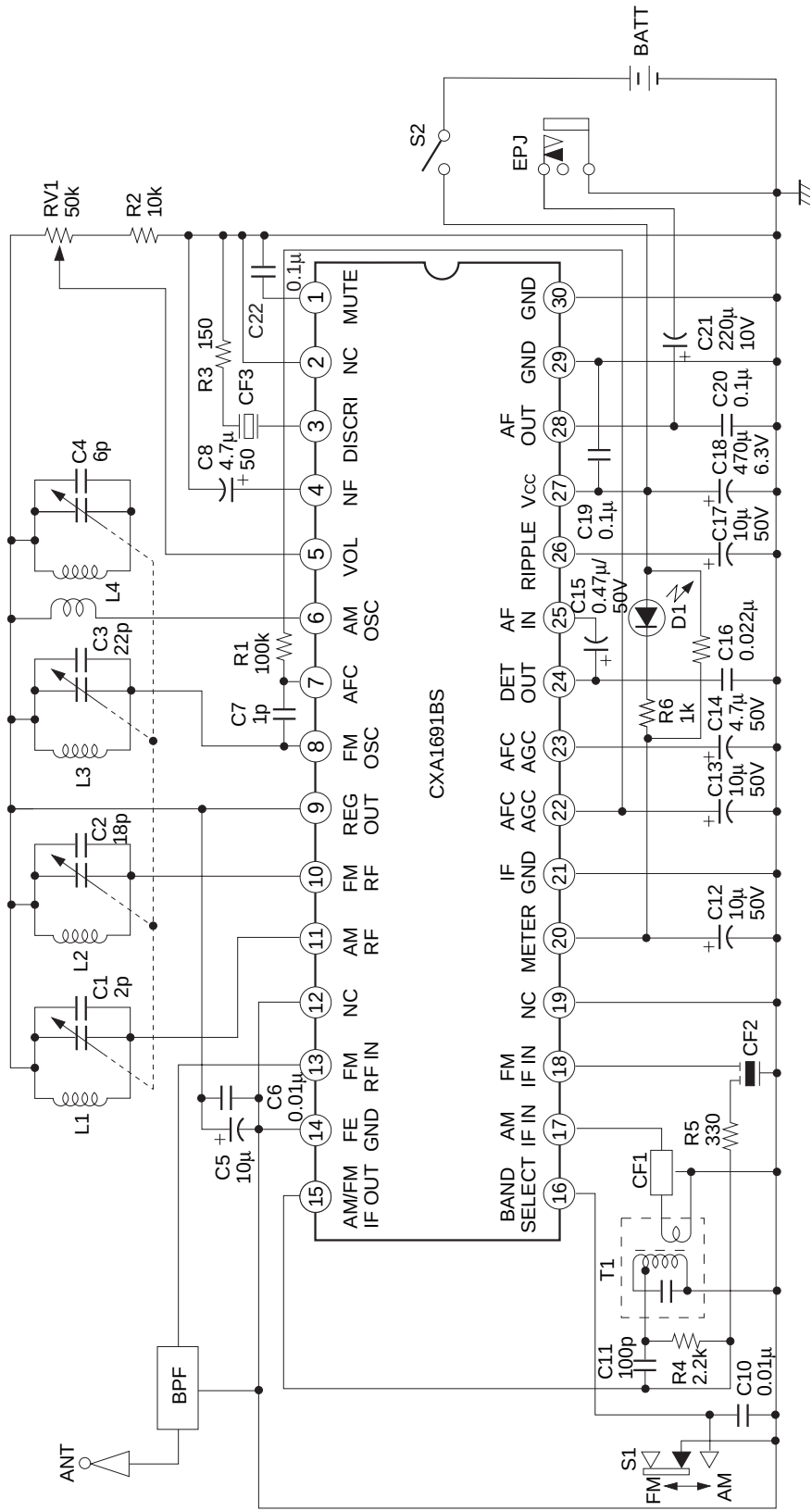


Application Circuit 1



Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

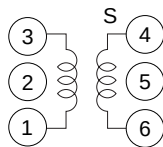
Application Circuit 2



Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

Coil data

AM OSC

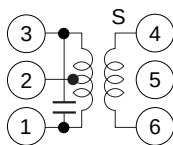


Core diameter $\varnothing$ 0.06 mm 2UEW

f (kHz)	L (μ H)	Qo	Number of windings (t)	
			1 to 3	4 to 6
796	270	125	107	29

Equivalent to L-5K7-H5 R12-1684X. Mitsumi Electric Co., Ltd.
or 7TRS-8441X TOKO Co., Ltd.

AM IFT

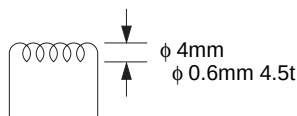


Core diameter $\varnothing$ 0.07 mm UEW

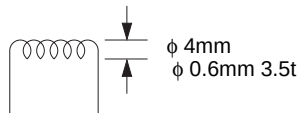
Co (pF)	Qo	Number of windings (t)		
		1 to 2	2 to 3	4 to 6
180	90	111	35	7

Equivalent to 21K7-H5 R12-8558A. Mitsumi Electric Co., Ltd.
or 7MC-7789N TOKO Co., Ltd.

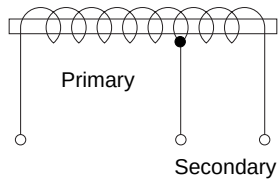
FM RF



FM OSC



AM bar antenna



f (kHz)	L (μ H)	Primary	Secondary
796	650	91 t	20 t

BPF PFWE8
(88 to 108 MHz) Soshin Electric Co., Ltd.

CF1 SFU-455B Murata Mfg. Co., Ltd. Or BFCFL-455 TOKO Co., Ltd.
CF2 SFE10.7MA5 Murata Mfg. Co., Ltd.
CF3 CDA10.7MC1 Murata Mfg. Co., Ltd.

CXA1691BM

Technical drawing of a 28-pin DIP package showing top, side, and end views with dimensions in millimeters.

Top View Dimensions:

- Pin 1 indicator circle.
- Pin 14 indicator circle.
- Pin 1 to Pin 14 pitch: 0.45 ± 0.1
- Pin 15 to Pin 28 pitch: 1.27
- Overall width: $18.8 - 0.1$
- Overall height: 10.3 ± 0.4
- Body height: $7.6 - 0.1$
- Body width: $+0.3$

Side View Dimensions:

- Overall height: 9.3
- Lead height: 0.5 ± 0.2
- Lead thickness: $0.2 - 0.05$
- Lead width: $+0.1$
- Lead angle: $0.1 - 0.05$
- Lead radius: $+0.2$
- Lead fillet radius: 0.15

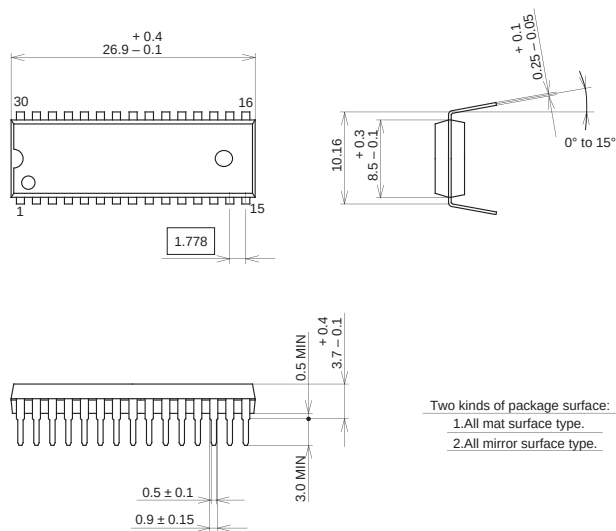
End View Dimensions:

- Pin pitch: 0.24
- Pin diameter: $\varnothing 0.24$

SONY CODE	SOP-28P-L04
EIAJ CODE	SOP028-P-0375
JEDEC CODE	_____

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	42/COPPER ALLOY
PACKAGE MASS	0.7g

30PIN SDIP (PLASTIC)



SONY CODE	SDIP-30P-01
EIAJ CODE	SDIP030-P-0400
JEDEC CODE	_____

MOLDING COMPOUND	EPOXY RESIN
LEAD TREATMENT	SOLDER/PALLADIUM PLATING
LEAD MATERIAL	COPPER ALLOY
PACKAGE MASS	1.8g

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